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Annealing impact on emission and phase varying of Nd-doped Si-rich-HfO₂ films prepared by RF magnetron sputtering

T. Torchynska  · L. G. Vega Macotela · L. Khomenkova · F. Gourbilleau · L. Lartundo Rojas

Abstract

HfO₂ films doped with Nd and Si atoms were produced by RF magnetron sputtering in argon plasma atmosphere. The effect of annealing treatment on the morphology, crystal structure and light emission of the films was investigated by means of the scanning electronic microscopy (SEM), energy dispersive X-ray spectroscopy (EDS), X-ray diffraction (XRD), photoluminescence (PL) and X-ray photoelectron spectroscopy (XPS). The thermal treatment was performed in the temperature range of $T_A = 800\text{--}1100$ °C in horizontal furnace with continuous nitrogen flow. For annealed Si-HfO₂:Nd films, the SEM study revealed the formation of the grains with the mean size of about 20–60 nm that show the tendency to enlarge with the T_A rise. Besides, the phase separation was observed and tetragonal HfO₂ and SiO₂ phases were detected by the XRD method for the films annealed at $T_A > 950$ °C. The PL study revealed that both Nd³⁺ ions and host defects contribute to PL emission whereas their relative contribution depends on the T_A and on the crystal phase of host matrix. The highest PL intensity of Nd³⁺ ions via 4f inner electronic shell levels was detected for $T_A = 950$ °C. The variation of PL intensity of Nd³⁺ ions was correlated with the change of PL intensity of the band caused by the host defects. These latter participate in the energy transfer towards Nd³⁺ ions. This statement was confirmed by XPS data, as well as by the shape of PL spectra. It was shown that the bright emission via Nd³⁺ ions can be achieved for those located in the tetragonal HfO₂ matrix.

1 Introduction

Hafnium dioxide (HfO₂) is interesting material for different applications. In nuclear industry this oxide can be used as the high temperature or high pressure materials. In electronics it competes with silicon oxide as the gate oxide or material for optical waveguides [1–4]. The advances of HfO₂ parameters are the extreme chemical inertness, high melting

temperature and high cross-section for thermal neutron capture [1]. The recent interest to hafnium dioxide was connected with its using as complementary metal-oxide semiconductor (CMOS) in integrated circuits due to its higher dielectric constant (k) important for the gate oxides [3, 4]. Other advantages of hafnium dioxide are the large conduction band offset (1.5 eV) and compatibility with polysilicon gate technology [5, 6].

It is worth to note that the HfO₂-based compounds were not well addressed early as a matrix for the rare-earth ions. Few groups only reported on the light emission obtained from Eu³⁺-doped HfO₂ nanotubes [7], Er³⁺-doped sol-gel SiO₂-HfO₂ waveguides [8, 9], and Nd³⁺, Er³⁺ or Pr³⁺ doped HfO₂ films [10–13].

Earlier, the interest to neodymium (Nd³⁺) ions has been caused by their application in inorganic laser materials. Nd³⁺ ions exhibit the broad absorption at 800 nm and intense emission in the IR range from 0.80 to 1.43 μm connected with a set of the ${}^4F_{3/2} \rightarrow {}^4I_J$ ($J = 9/2, 11/2, 13/2$) optical transitions in the 4f electronic shell [14, 15].

The previous study of Si-rich HfO₂ films co-doped with rare-earth ions [10, 11] showed that the bright photoluminescence (PL) in visible and infrared spectral ranges, related to

the rare-earth ions, can be obtained from the films annealed either at 900–950 °C [10] or at 950–1050 °C [11]. The reasons of this phenomenon were unclear and required additional study. Moreover, the chemical bonding of Hf, Si, O and rare-earth ions was not analyzed. In this paper, we report on the investigation of PL emission and crystal structure of Si-rich HfO₂ films doped with Nd ions grown by radio frequency (RF) magnetron sputtering. The phase separation process in these films induced by thermal treatment was controlled by means of X-ray diffraction (XRD) method. To understand the impact of thermal treatments on the Nd ion surrounding, the X-ray photoelectron spectroscopy (XPS) was used.

2 Experimental details

The films were grown by RF magnetron sputtering on the 2-inch, B-doped, (100) oriented Si wafers with a resistivity of 15 Ω cm. Prior to deposition, the substrates were submitted to standard RCA cleaning, dipped in 10% HF solution, rinsed in distilled water and dried in nitrogen flow. After this, the substrates were placed immediately in load-lock of deposition unit. The HfO₂ target (99.9% Testbourn Ltd.), topped with the calibrated 1 cm² Si and Nd₂O₃ pellets that covered of 16% target surface each, was used. The growth of Si–HfO₂:Nd films was carried out in pure Ar plasma with the argon flow ($f_{Ar} = 3$ sccm). The RF power, substrate temperature, plasma pressure and substrate-cathode distance were 0.74 W/cm², 400 °C, 0.03 mbar and 57 mm, respectively. The deposition time was about 200 min allowed growing of homogeneous films with the 410-nm thickness. After deposition, the substrate with the film was cut on the pieces with the dimensions of 1 × 1 cm² (so-called as samples) to study the effect of different annealing temperatures. Annealing treatment was carried out in a conventional horizontal furnace at the temperatures $T_A = 800$ – 1100 °C for $t_A = 15$ min in continuous nitrogen flow (48 sccm). For this purpose, the samples were placed in the cold zone of the furnace and kept there during 15 min in continuous nitrogen flow. Then (under continuous nitrogen flow), they were transferred in the hot zone of the furnace and annealed there during 15 min. After annealing, the samples were extracted from the hot zone and cooled down to room temperature in nitrogen flow. The heating and cooling rates were about 45 °C/s.

To study the surface morphology, as well as to obtain the information on film chemical composition, a scanning electronic microscope (SEM) Quanta 3D FEG-FEI with a detector Apollo X10 mark EDAX for the X-ray energy dispersive spectroscopy (EDS) was used.

X-ray diffraction (XRD) patterns were recorded at the symmetric geometry on Model X[”] PERT MRD equipment with a Pixel detector, three axis goniometry and parallel

collimator, with the angular resolution of 0.0001°. X-ray beam was from the Cu source (K_1 line, $\lambda = 1.5406$ Å).

PL spectra were recorded in the 400–1000 nm spectral range using a Jobin–Yvon TRIAX 180 monochromator with a Hamamatsu E717-500 PMT Socket Assembly and a SRS lock-in amplifier (SP830 DPS) and in 800–1500 nm spectral range using Jobin THR 1000 monochromator with Hamamatsu C9940-02 PMT Cooled Housing and a SRS lock-in amplifier (SP830 DPS).

To detect the chemical compositions of the films as well as Nd ion surrounding, the X-ray photoelectron spectroscopy (XPS) has been realized on the Thermo Scientific™ K-Alpha™ XPS spectrometer operated at 15 kV (90 W) at a pressure of 1.33×10^{-7} Pa. In this case, the Al K_{α} radiation (with energy of 1486.7 eV) was used. The X-ray beam of 400 μm cross-section was applied in two pass energy modes of 160 and 40 eV. To analyze the XPS spectrum, the Thermo Avantage V5.938 software was applied. All experiments were carried out at 300 K.

3 Results and discussion

3.1 Surface morphology and chemical composition

Figure 1 shows the SEM images of as-deposited (AD) and annealed Si–HfO₂:Nd films. The surface of AD films shows the presence of the grains with the sizes of 20–60 nm (Fig. 1a). The grain sizes increase up to 40–100 nm after film annealing at 950 and 1100 °C (Fig. 1b, c). The last effect is connected with the crystallization process occurred at high temperatures.

The film composition analyzed by the EDS technique is shown in Fig. 2. In all films, the Hf, Si, O, N and Nd elements were detected. The O signal enlarges significantly with increasing the annealing temperature (Fig. 2a). The O and N signal variation after annealing can be owing to the surface adsorption of these elements from an annealing atmosphere and then their diffusion into the films.

3.2 XRD study

The XRD patterns of Si–HfO₂:Nd films are shown in Fig. 3. The AD film demonstrates XRD peaks (Fig. 3, curves 1) that can be attributed to the different phases. The high intensity XRD peak at $2\theta = 69.173^\circ$ (f) is identified as XRD signal from the (400) planes in cubic Si crystal structure (ICSD Ref. code 00-005-0490). This signal is related to the Si substrate.

XRD peaks with the small intensity (Fig. 3, curves 1) detected at $2\theta = 35.595^\circ$ (b), 56.372° (c) and 69.231° (g) are assigned to the X-ray diffraction from the (112), (213) and (204) planes, respectively, in the tetragonal

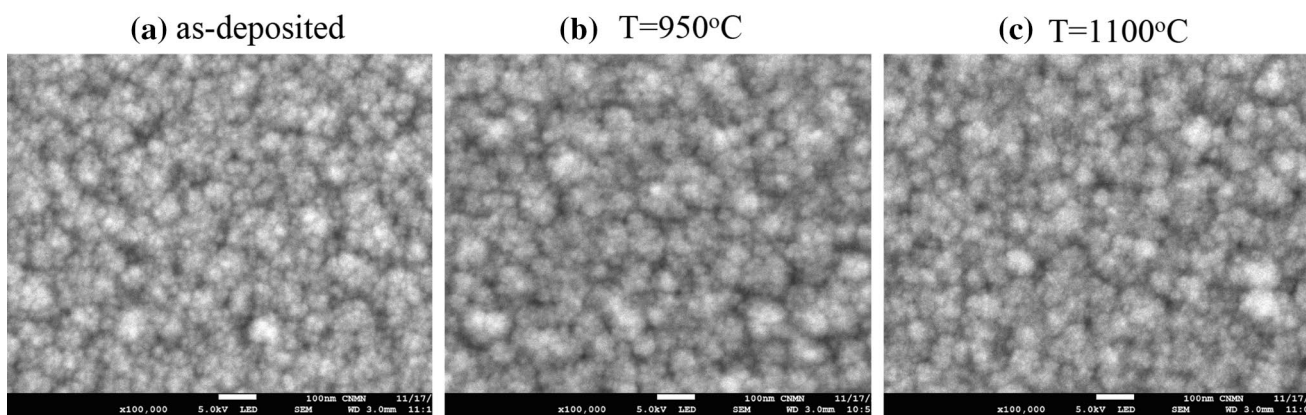


Fig. 1 SEM images of Si-HfO₂:Nd films as-deposited (a) and annealed at 950 (b) and 1100 °C (c)

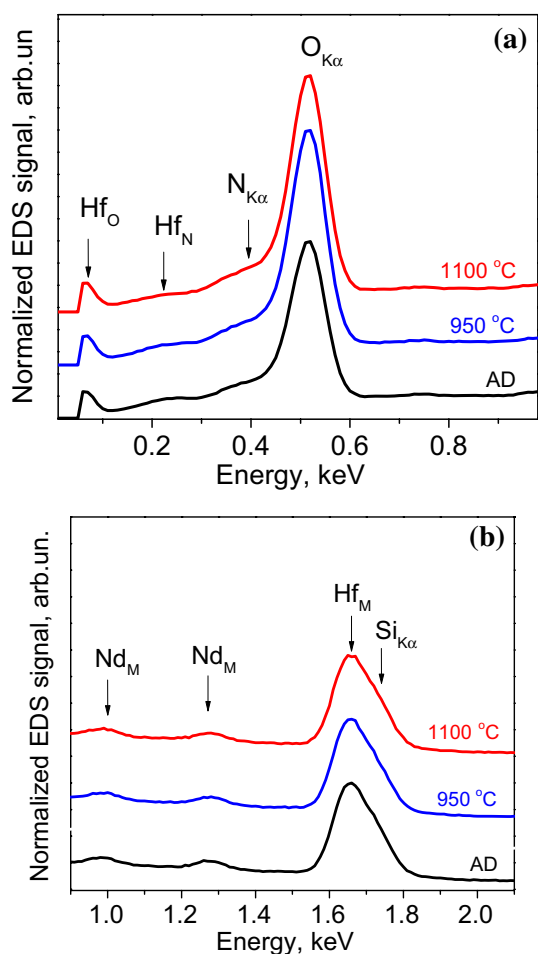


Fig. 2 EDS spectra of Si-HfO₂:Nd films: as-deposited (curve 1) and annealed at 950 (curve 2) and 1100 °C (curve 3)

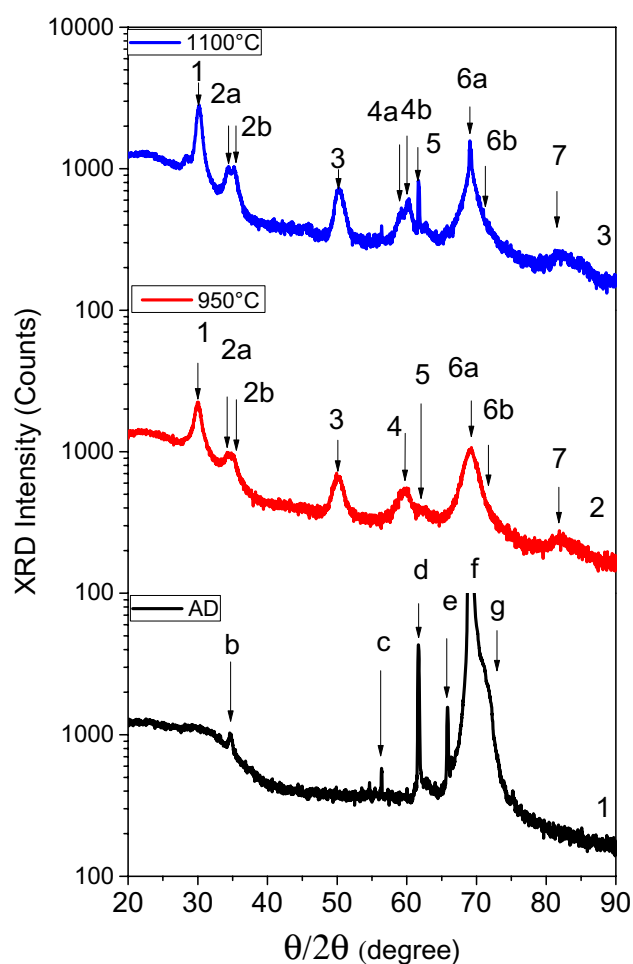


Fig. 3 XRD spectra of Si-HfO₂:Nd films: as-deposited (curve 1) and annealed at 950 (curve 2) and 1100 °C (curve 3)

HfSiO₄ phase (ICSD Ref. code 00-008-0345). Meanwhile, the XRD peaks at $2\theta = 61.632^\circ$ (d) and 66.215° (e) were attributed to the diffraction from the (241) and (338) planes in the tetragonal Nd₂Si₂O₇ phase (ICSD Ref.

code 01-089-5347). It is supposed that the appearance of tetragonal HfSiO₄ and Nd₂Si₂O₇ phases can be favored in AD films by high enough substrate temperature (400 °C).

Annealing the Si-HfO₂:Nd film at $T_A=950$ °C stimulates structure variation (Fig. 3, curve 2). The XRD signals from Nd₂Si₂O₇ and HfSiO₄ tetragonal phases disappeared (Fig. 3, curve 2) that can be connected with the decomposition of both these phases. At the same time, the XRD peaks connected with the tetragonal HfO₂ phase were detected at $2\Theta=30.052^\circ$ (1), 34.812° (2a), 35.052° (2b), 50.452° (3), 59.952° (4), 61.936° (5) and 82.452° (7) (Fig. 3, curve 2). These peaks are related to the (112), (002), (200), (220), (311), (222) and (204) planes in the tetragonal HfO₂ phase (ICSD Ref. code 00-008-0342), respectively. Additionally, the peak 6a shifts towards $2\Theta=69.272^\circ$ (6a) due to its overlapping with the XRD peak at $2\Theta=70.603^\circ$ (peak 6b) (Fig. 3, curve 2). The last one can be assigned to the X-ray diffraction from a (002) plane in the tetragonal SiO₂ phase (ICSD Ref. code 00-045-1374).

Annealing at $T_A=1100$ °C did not change significantly the XRD pattern of the Si-HfO₂:Nd film (Fig. 3, curve 3) and all XRD peaks related to the tetragonal HfO₂ phase can be seen clearly. The peak intensities increase and their full width at half maximum (FWHM) decreases. The last fact testifies to enlarging the HfO₂ nanocrystal sizes. The nanocrystal sizes (coherent domain sizes) estimated using the Scherrer's formula from the XRD peaks related to the tetragonal HfO₂ were 5 nm and 8 nm after annealing at 950 and 1100 °C, respectively.

Furthermore, the first XRD peak 30.052° shifted to 30.192° and the small intensity XRD peaks (4b, 5, 6b) appeared after annealing at $T_A=1100$ °C (Fig. 3, curve 3). Annealing at higher temperatures (1000–1100 °C) stimulates the silicon oxide crystallization in the studied films that is accompanied by appearing the other set of XRD peaks at $2\Theta=30.192^\circ$ (1), 56.372° (5), 60.472° (4b) and 70.603° (6b) corresponded to the (110), (121), (066) and (002) planes in the tetragonal SiO₂ phase (ICSD Ref. code 00-045-1374).

3.3 PL study

PL spectra of as-deposited and annealed Si-HfO₂:Nd films are shown in Fig. 4. The total PL intensity increases significantly after annealing at 950 °C, but it changes slightly after annealing at 1100 °C in comparison with the AD state (Fig. 4). PL spectra consist of several PL bands related to the optical transition in the 4f inner electronic shell of Nd³⁺ ions with the peaks (1–10) in the spectral range of 350–1500 nm (Fig. 4, Table 1). Additionally, the PL peak X has been detected and assigned to emission via native host defects (Fig. 4, Table 1). The comparison of PL spectra shows that increasing the PL intensity and its decreasing correlate with varying the PL intensity of the band X in Fig. 4. It is clear that the contribution of Nd³⁺ ions and host defects in film emission depends on annealing temperatures and on the crystal phase of host matrix (Table 1, Fig. 4).

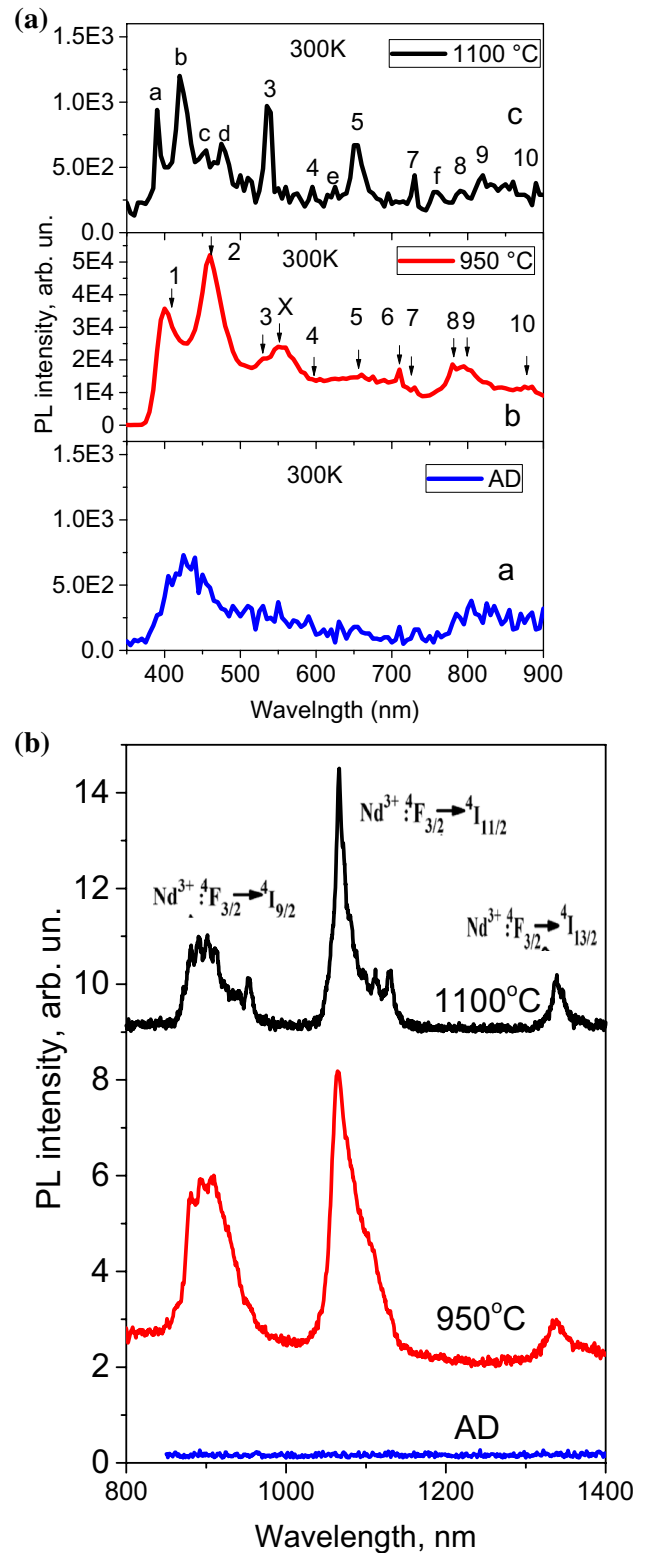


Fig. 4 PL spectra of Si-HfO₂:Nd films: as-deposited and annealed at 950 and 1100 °C recorded in the visible (a) and infrared (b) spectral ranges

Table 1 Optical transitions detected in the films (Fig. 4)

Number	Wavelength (nm)	Optical transition	References
$T_A = 950\text{ }^\circ\text{C}$			
1	400	$^4P_{3/2} \rightarrow ^4I_{9/2}, ^2P_{1/2} \rightarrow ^4I_{9/2}$	[19]
2	455	$^4G_{11/2} \rightarrow ^4I_{9/2}, ^4G_{9/2} \rightarrow ^4I_{9/2}$	[19]
3	530	$^4G_{7/2} \rightarrow ^4I_{9/2}$	[13]
X	555	VO	[10,11]
4	605	$^2G_{7/2} \rightarrow ^4I_{9/2}$	[11]
5	660	$^4F_{9/2} \rightarrow ^4I_{9/2}$	[15]
6	710	$^4F_{7/2} \rightarrow ^4I_{9/2}$	[15]
7	730	$4S_{3/2} \rightarrow 4I_{9/2}$	[15]
8	780	$4F_{5/2} \rightarrow 4I_{9/2}$	[15]
9	800	$^4H_{7/2} \rightarrow ^4I_{9/2}$	[15]
10	885	$^4F_{3/2} \rightarrow ^4I_{9/2}$	[14,19]
$T_A = 1100\text{ }^\circ\text{C}$			
a	390	$^4P_{3/2} \rightarrow ^4I_{9/2}$	[15]
b	420	$2P_{1/2} \rightarrow 4I_{9/2}$	[15]
c	455	$4G_{11/2} \rightarrow 4I_{9/2}$	[13]
d	475	$4G_{9/2} \rightarrow 4I_{9/2}$	[19]
e	625	$4H_{11/2} \rightarrow 4I_{9/2}$	[13]
f	760	$^4H_{9/2} \rightarrow ^4I_{9/2}$	[15]

It was shown early that the emission of pure HfO_2 is characterized by the PL bands in the ultraviolet (4.0–4.2 eV) and visible (2.2–3.5 eV) spectral ranges [10, 11]. The UV emission was attributed either to the emission of the self-trapped exciton or to oxygen vacancies. Since the exciton emission is usually quenched to 300 K, the most probable center for UV emission are oxygen vacancies (Fig. 4a). Along with this, visible emission at 300 K was attributed to the carrier recombination via oxygen vacancies with trapped electrons [10, 11]. In present study, the band X centered at 555 nm (≈ 2.23 eV), which appeared after annealing at

950 °C (Fig. 4b), can be attributed to the optical transitions via different types of oxygen vacancies. The film oxidation while annealing at 1100 °C reduces the number of oxygen vacancies in the films and, as result, the PL intensities of the band X and all PL bands related to the recombination via Nd ions fall down in the PL spectrum (Fig. 4).

The native defects can influence on the excitation of rare-earth ions in the films. It is known that the absorption cross-section of rare-earth ions for $4f-4f$ transitions is about $10^{-19}-10^{-21}$ cm^{-2} and require a high power for the direct excitation [16–18]. It was shown early that the host-mediated excitation of $4f-4f$ transitions can be very effective owing to the excitation energy transfer. In this case, the high intensity of Nd^{3+} related PL bands (Fig. 4b) can be assigned to the efficient interaction of host defects, oxygen vacancies [19, 20], with Nd^{3+} ions. To confirm this conclusion, the XPS spectra of studied films were investigated.

3.4 XPS study

XPS spectra of $\text{Si-HfO}_2:\text{Nd}$ films measured in the high resolution mode for the AD film and after annealing at 950 and 1100 °C are shown in Figs. 5 and 6. The four XPS lines related to Hf 4f, Si 2p, O 1s and Nd 3d have been monitored.

For as-deposited film, the XPS spectra showed the Hf doublet: Hf $4f_{5/2}$ and Hf $4f_{7/2}$ peaked at 18.48 and 16.98 eV, respectively, which are typical for the Hf–O bonds in hafnium oxide [21–23]. Additionally, the small intensity XPS peak is detected at 13.58 eV that can be attributed to the Hf $4f_{7/2}$ line in the metallic hafnium [21].

The XPS peaks of the main Hf 4f doublet did not change their positions after film annealing at 950 °C (Fig. 5a), whereas a small shift of these XPS peaks toward lower binding energies was found for the film annealed at 1100 °C (Fig. 5a). Moreover, the small XPS peak at 13.58 eV disappeared after annealing at 950 °C and the intensity of the

Fig. 5 High resolution XPS spectra of Hf 4f (a) and Si 2p (b) lines of $\text{Si-HfO}_2:\text{Nd}$ films: as-deposited (curve 1) and annealed at 950 °C (curve 2) and 1100 °C (curve 3)

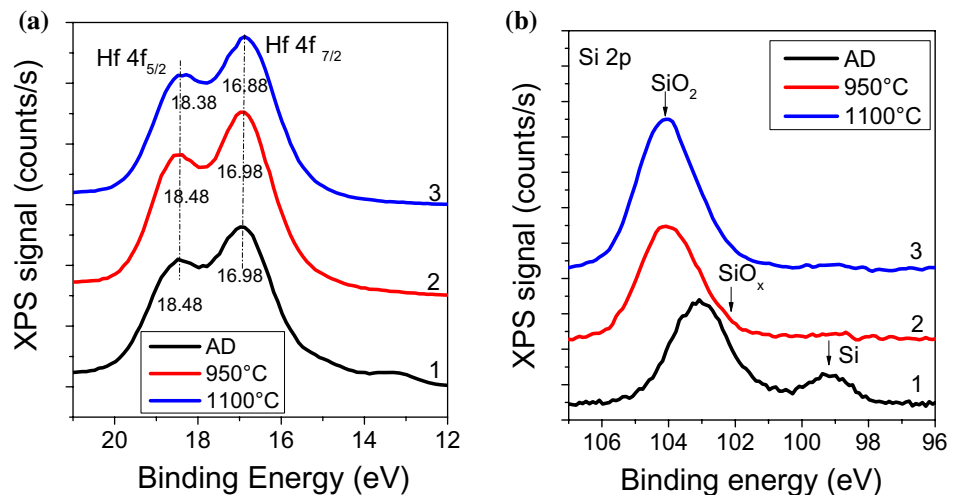
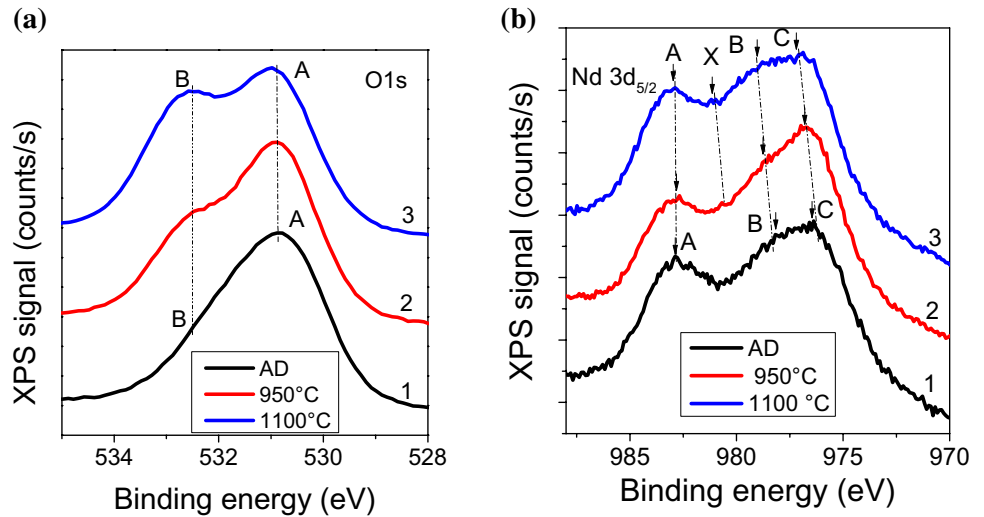


Fig. 6 High resolution XPS spectra of O1s (a) and Nd 3d (b) lines of Si-HfO₂:Nd films: as-deposited (curve 1) and annealed at 950 (curve 2) and 1100 °C (curve 3)



main Hf 4f doublet increased. Thus, an annealing stimulated pronounced formation of Hf–O bonds with Hf⁴⁺ charge state (corresponded to Hf charge state in HfO₂ phase). This occurs via additional oxidation of metallic Hf (reflected by the change of Hf ion charges from Hf⁰ in metallic hafnium to Hf⁴⁺ in HfO₂) and/or via HfSiO_x phase separation and formation of HfO₂ phase.

However, the crystallization process that takes place in hafnium oxide at 950 °C did not affect the peak positions of main Hf 4f doublet. Meanwhile, the small shift of Hf 4f doublet peaks to lower binding energies after annealing at 1100 °C may be connected with the effective Si oxidation and formation of tetragonal SiO₂ phase that leads to some destruction of the hafnium oxide phase.

Two XPS peaks at 99.18 eV and 103.08 eV, related to the Si 2p_{3/2} line, are detected for the AD state of Si–HfO₂:Nd film (Fig. 5b). The peak at 99.18 eV is connected with the silicon nanocrystals (NC) in Si–HfO₂:Nd films [21]. The second peak at 103.08 eV can be attributed to the Si²⁺ ions in silicon suboxide, SiO_x [21, 22]. Si NC oxidation at higher temperatures leads to disappearing the XPS peak at 99.18 eV. Simultaneously, the XPS intensity of high binding energy Si 2p peak increases and it shifts to 104.08 eV. This last peak position corresponds the Si 2p_{3/2} line of Si⁴⁺ ions in silicon dioxide, SiO₂ [21].

High resolution XPS spectra of the oxygen O1s line in the Si–HfO₂:Nd films are presented in Fig. 6a. In the AD state only one asymmetric XPS peak has been detected at 530.88 eV (Fig. 6a). The last peak can be attributed to the Hf–O bonds in the Si–HfO₂:Nd films [24, 25]. This peak position in XPS spectra does not change after annealing at 950 °C, but shifts to 530.98 eV after annealing at 1100 °C (Fig. 6a). Simultaneously, the thermal treatment stimulates the growth of the second oxygen XPS peak at 532.28 eV. Note, that the second O1s peak appearing at high temperature correlates with the Si

oxidation upon annealing. This XPS peak at 532.28 eV can be attributed to the Si–O bonds in silicon oxides [21]. It is worth to note that the constant position of the first O1s XPS peak (530.88 eV) in hafnium oxide after annealing at 950 °C correlates with the constant position of the main Hf 4f doublets after this annealing. It means that short ordering of Hf–O bonds in the hafnium oxide varies a little upon the crystallization of this phase during annealing.

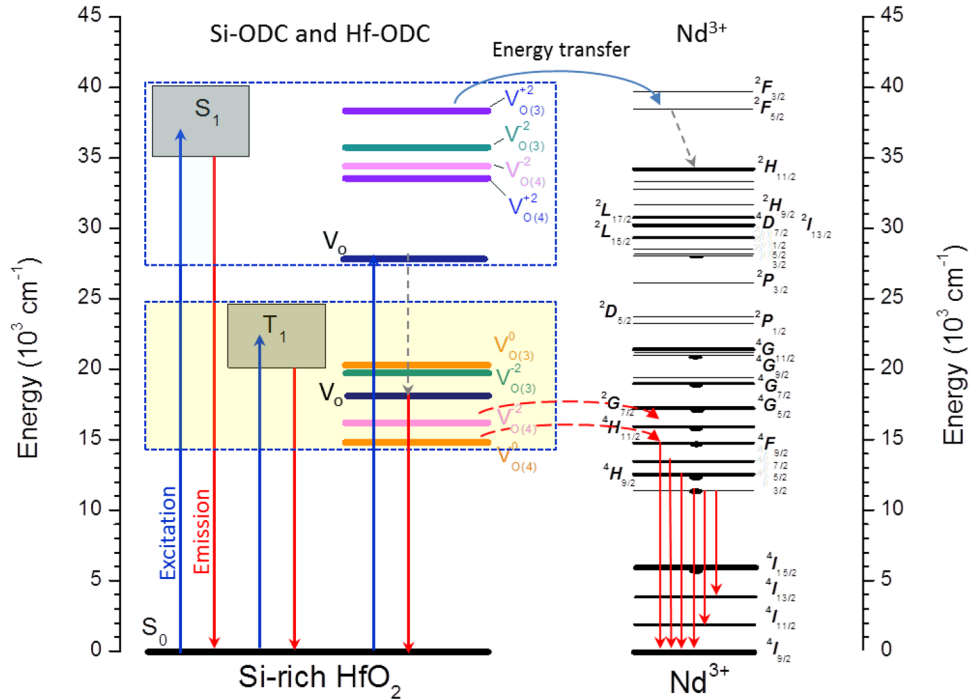
High resolution XPS spectra of Nd 3d lines are presented in Fig. 6b. XPS spectra permit to detect the Nd 3d_{5/2} peak (A) at 982.5 eV in the AD film state that, as a rule, is attributed to the Nd³⁺ ions in neodymium oxide (Nd₂O₃) [22–25]. Additionally, in XPS spectra of Nd3d lines two other overlapped peaks B and C located at 978.08 eV (B) and 976.48 eV (C), respectively, can be seen. The shift of Nd 3d peaks to lower binding energies, in comparison with the Nd³⁺ ion peak at 982.5 eV, permits to suppose that B and C peaks belong to the Nd ions with other charges [24, 25]. The analysis of published results has summarized in Table 2, where the peak positions of Nd 3d_{5/2} lines are shown for the different Nd ion charge states. Presented analysis permits to assign the XPS peaks B and C to Nd¹⁺ and Nd⁰ states. The appearance of Nd atoms with the charge states Nd⁰ and Nd¹⁺ may be owing to their insufficient oxidation at the film growth in Ar atmosphere.

The film thermal treatment at 950 °C leads to the preferential growth of the peak B and C intensities and their shift to the higher binding energies of 978.68 eV (B) and 976.78 eV (C) that again testifies to insufficient oxidation the Nd atoms and,

Table 2 Binding energy of Nd 3d_{5/2} peaks for different charge states of Nd ion

Nd 3d _{5/2} lines	Nd ⁰	Nd ¹⁺	Nd ²⁺	Nd ³⁺	References
Binding energy (eV)	976.18	978.29	980.30	982.50	[24, 25]

Fig. 7 Schematic presentation of different radiative centers and possible ways for energy transfer towards Nd^{3+} ions. Si-ODC and Hf-ODC are oxygen vacancies (oxygen deficient centers) located in SiO_2 (and/or SiO_x) and HfO_2 phases



as consequence, the lack of oxygen in the HfO_2 matrix. It is clear that this situation is favorable for the high concentration of oxygen vacancies in the host HfO_2 matrix, which are necessary for the energy transfer from host defects to Nd ions at the efficient Nd ion excitation (Fig. 7). Meanwhile, annealing at 1100°C stimulates the efficient oxidation and preferential growth of the peak A intensity that related to the Nd^{3+} ions in neodymium oxide. Simultaneously, the peaks B and C continue shifting to higher binding energies of 978.98 eV (B) and 977.08 eV (C) and the new small peak X appearing. The last one can be attributed to the Nd^{2+} ion states. Thus, all mentioned features in varying the Nd $3d_{5/2}$ peaks are connected with efficient oxidation of Nd atoms at higher temperature annealing. Furthermore, the variation of Nd $3d_{5/2}$ peaks with annealing permits to confirm that for the bright emission via Nd ions is necessary the insufficient oxidation of Nd ions and the host HfO_2 matrix. The effect of decreasing the PL intensity of deep level emission bands after annealing in oxygen atmosphere was detected in the $\text{ZnO}:\text{Gd}$ films early [26].

4 Conclusions

The effects of annealing conditions on the phase chemical compositions and crystal structure of the $\text{Si-HfO}_2:\text{Nd}$ films have been studied. The correlation between the bright emission via the $4f$ inner electronic shell of Nd ions and the high intensity of PL band X, related to emission via the oxygen vacancies in the host HfO_2 matrix, has been revealed. The XPS study, additionally, confirms that for the bright

emission via Nd ions is necessary the insufficient oxidation of Nd ions and the host tetragonal HfO_2 matrix. This condition is favored for the high concentration of oxygen vacancies in the HfO_2 films that is necessary for the efficient energy transfer toward Nd ions.

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